

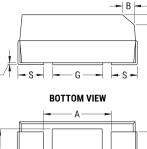
## T495X475M050ATE3007280

T495, Tantalum, MnO2 Tantalum, 4.7 uF, 20%, 50 VDC, SMD, MnO2, Molded, Low ESR, 300 mOhms, 7343, Height Max = 4.3 mm

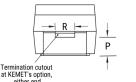
**CATHODE (-) END VIEW** 

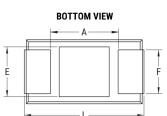


ANODE (+) END VIEW



SIDE VIEW





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Click here for the 3D model.

Dimensions	
Footprint	7343
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
Н	4mm +/-0.3mm
Т	0.13mm REF
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
А	3.6mm MIN
В	0.5mm +/-0.15mm
E	3.5mm REF
G	3.5mm REF
Р	1.7mm REF
R	1mm REF
Х	0.1mm +/-0.1mm

Т

Packaging Specifications			
Packaging	T&R, 330mm		
Packaging Quantity	2000		

General Information		
Series	T495	
Dielectric	MnO2 Tantalum	
Style	SMD Chip	
Description	SMD, MnO2, Molded, Low ESR	
Features	Low ESR	
RoHS	Yes	
Termination	Tin	
AEC-Q200	No	
Component Weight	652.04 mg	
Shelf Life	156 Weeks	
MSL	1	

Specifications		
Capacitance	4.7 uF	
Capacitance Tolerance	20%	
Voltage DC	50 VDC (85C), 33.5 VDC (125C)	
Temperature Range	-55/+125°C	
Rated Temperature	85°C	
<b>Dissipation Factor</b>	4% 120Hz 25C	
Failure Rate	N/A	
Resistance	300 mOhms (100kHz 25C)	
Ripple Current	742 mA (rms, 100kHz 25C), 667.8 mA (rms, 85C), 296.8 mA (rms, 125C)	
Leakage Current	2.4 uA (5min 25°C)	

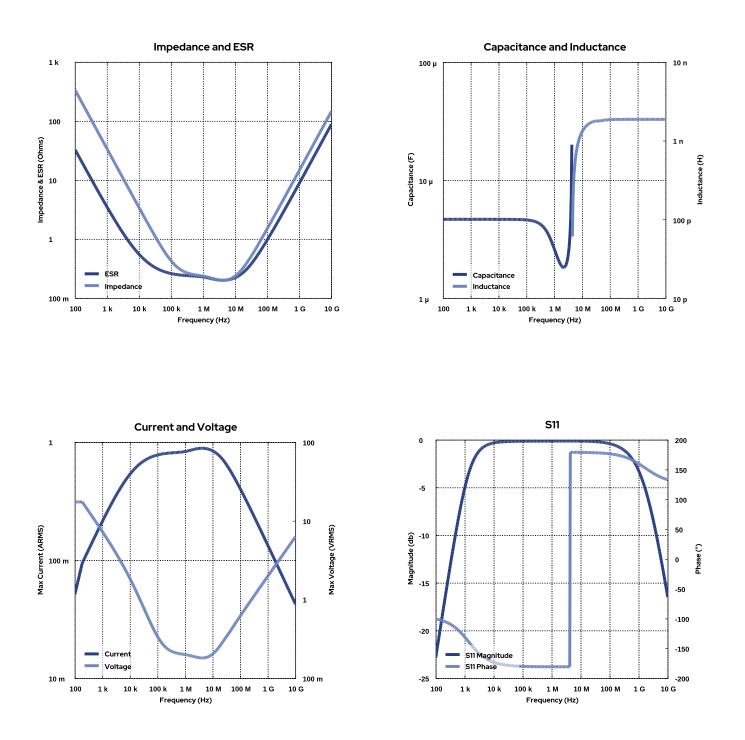
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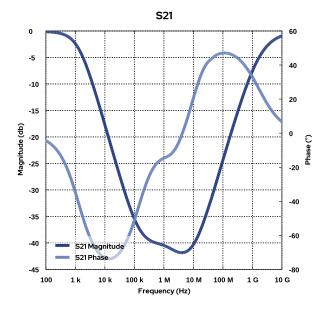
## Simulations

For the complete simulation environment please visit K-SIM.





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## These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.
- The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
- The effects shown herein are based on measured data from a multiple part sample of the parts in question.
- Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance. The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages generated at any other
- harmonics.
- Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.

单击下面可查看定价,库存,交付和生命周期等信息

>>KEMET(基美)